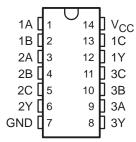
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- Operates From 1.65 V to 3.6 V
- Max t<sub>pd</sub> of 3 ns at 3.3 V
- ±24-mA Output Drive at 3.3 V
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

#### D, DGV, NS, OR PW PACKAGE (TOP VIEW)



# description/ordering information

This triple 3-input positive-NAND gate is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74ALVC10 performs the Boolean function  $Y = \overline{A \bullet B \bullet C}$  or  $Y = \overline{A} + \overline{B} + \overline{C}$  in positive logic.

#### **ORDERING INFORMATION**

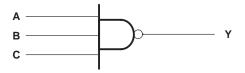
TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	SOIC - D	Tube	SN74ALVC10D	ALVC10
-40°C to 85°C	SOP - NS	Tape and reel	SN74ALVC10NSR	ALVC10
-40 C to 65 C	TSSOP - PW	Tape and reel	SN74ALVC10PWR	VA10
	TVSOP - DGV	Tape and reel	SN74ALVC10DGVR	VA10

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

# FUNCTION TABLE (each gate)

	INPUTS		OUTPUT
Α	В	С	Y
Н	Н	Н	L
L	X	Χ	Н
Х	L	Χ	Н
Х	X	L	Н

## logic diagram, each gate (positive logic)





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>		–0.5 V to 4.6 V
Input voltage range, V <sub>I</sub> (see Note 1)		
Output voltage range, V <sub>O</sub> (see Notes 1 and 2)		$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, $I_{IK}$ ( $V_I < 0$ )		
Output clamp current, IOK (VO < 0)		
Continuous output current, IO		±50 mA
Continuous current through V <sub>CC</sub> or GND		±100 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3):	: D package	86°C/W
	DGV package	127°C/W
	NS package	76°C/W
	PW package	113°C/W
Storage temperature range, T <sub>stg</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. This value is limited to 4.6 V maximum.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

# recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
VCC	Supply voltage		1.65	3.6	V	
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.65 × V <sub>CC</sub>			
$V_{IH}$	High-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7		V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2			
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		$0.35 \times V_{CC}$		
$V_{IL}$	Low-level input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	V	
	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$			0.8		
٧ <sub>I</sub>	Input voltage		0	3.6	V	
٧o	Output voltage		0	VCC	V	
		V <sub>CC</sub> = 1.65 V		-4		
1	High-level output current	V <sub>CC</sub> = 2.3 V		-12	mA	
ЮН		V <sub>CC</sub> = 2.7 V		-12		
		V <sub>CC</sub> = 3 V		-24		
		V <sub>CC</sub> = 1.65 V		4		
1	Lave lavel autout august	V <sub>CC</sub> = 2.3 V		12	A	
lOL	Low-level output current	V <sub>CC</sub> = 2.7 V		12	mA	
		V <sub>CC</sub> = 3 V		24		
Δt/Δν	Input transition rise or fall rate		5	ns/V		
TA	Operating free-air temperature	-40	85	°C		

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	ONDITIONS	Vcc	MIN	TYP	MAX	UNIT
	I <sub>OH</sub> = -100 μA		1.65 V to 3.6 V	V <sub>CC</sub> -0.	2		
	$I_{OH} = -4 \text{ mA}$	1.65 V	1.2				
	I <sub>OH</sub> = -6 mA		2.3 V	2			
Voн			2.3 V	1.7			V
	I <sub>OH</sub> = -12 mA		2.7 V	2.2			
		3 V	2.4				
	I <sub>OH</sub> = -24 mA		3 V	2			
	I <sub>OL</sub> = 100 μA	1.65 V to 3.6 V			0.2		
	I <sub>OL</sub> = 4 mA	1.65 V			0.45		
V <sub>OL</sub>	I <sub>OL</sub> = 6 mA		2.3 V			0.4	V
VOL	loι = 12 mΛ	2.3 V			0.7	ı v	
	I <sub>OL</sub> = 12 mA		2.7 V			0.4	
	I <sub>OL</sub> = 24 mA		3 V			0.55	
lį	$V_I = V_{CC}$ or GND		3.6 V			±5	μΑ
Icc	$V_I = V_{CC}$ or GND,	IO = 0	3.6 V			10	μΑ
ΔlCC	One input at V <sub>CC</sub> – 0.6 V,	Other inputs at V <sub>CC</sub> or GND	3 V to 3.6 V			750	μΑ
C <sub>i</sub>	$V_I = V_{CC}$ or GND		3.3 V		4		pF

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

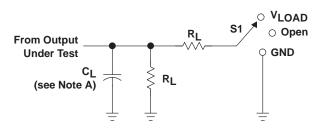
# switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> =		V <sub>CC</sub> =		VCC =	2.7 V	V <sub>CC</sub> =		UNIT
	(1141 01)	(0011 01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> pd	A, B, or C	Υ	1.1	4.8	1	3		3.3	1	3	ns

# operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER		TEST CONDITIONS		V <sub>CC</sub> = 1.8 V	V <sub>CC</sub> = 2.5 V V <sub>CC</sub> = 3.3 V		UNIT
			1231 00	DINDITIONS	TYP TYP		TYP	ONII
	C <sub>pd</sub>	Power dissipation capacitance per gate	$C_{L} = 0$ ,	f = 10 MHz	23	24	26	pF

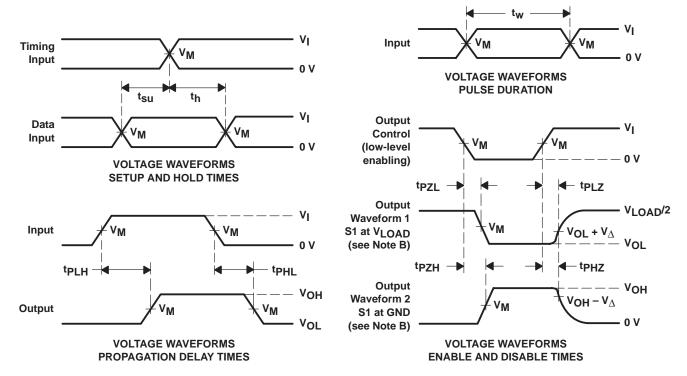
#### PARAMETER MEASUREMENT INFORMATION



TEST	S1
<sup>t</sup> pd	Open
tPLZ/tPZL	V <sub>LOAD</sub>
tPHZ/tPZH	GND

**LOAD CIRCUIT** 

V	INPUT		V	V	C.	D.	V
vcc	٧ <sub>I</sub>	t <sub>r</sub> /t <sub>f</sub>	ν <sub>M</sub>	VLOAD	CL	RL	$v_{\scriptscriptstyle{\Delta}}$
1.8 V ± 0.15 V	VCC	≤ <b>2</b> ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	30 pF	<b>1 k</b> Ω	0.15 V
2.5 $\pm$ 0.2 V	VCC	≤2 ns	V <sub>CC</sub> /2	2×V <sub>CC</sub>	30 pF	<b>500</b> Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V $\pm$ 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50~\Omega$ .
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms



# DGV (R-PDSO-G\*\*)

## 24 PINS SHOWN

#### **PLASTIC SMALL-OUTLINE**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

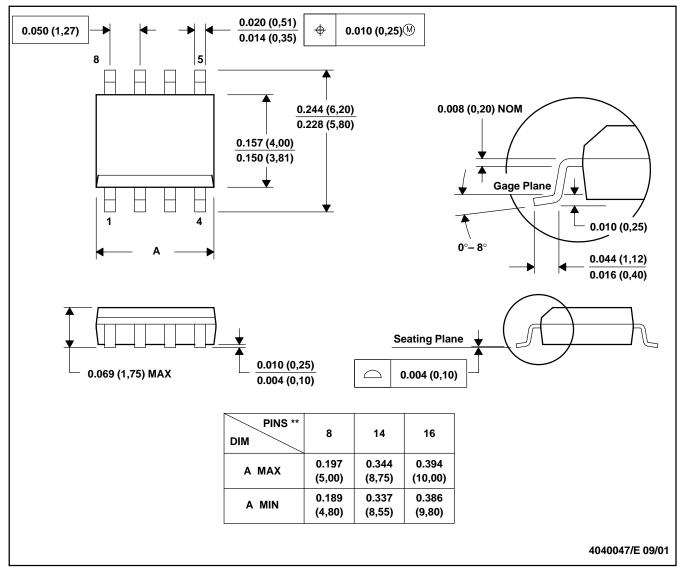
C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

## D (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

#### **8 PINS SHOWN**



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

# **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

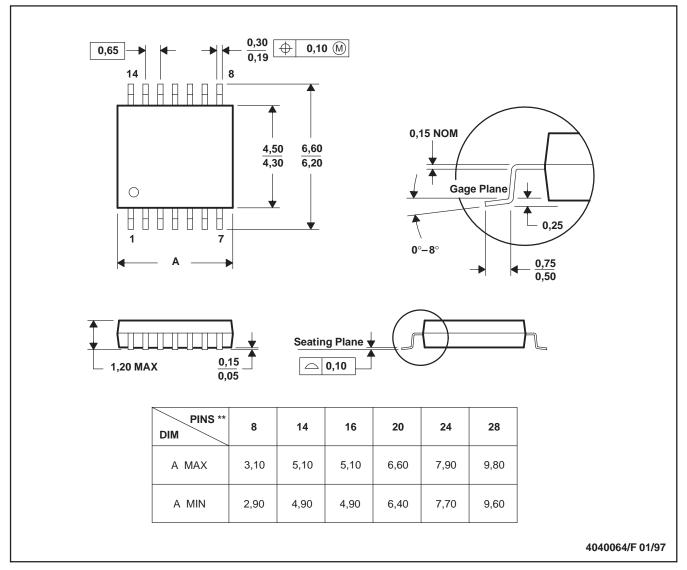
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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